SDFS076A - D2932, MARCH 1987 - REVISED OCTOBER 1993

- Eight Latches in a Single Package
- 3-State Bus-Driving True Outputs
- Full Parallel Access for Loading
- Buffered Control Inputs
- Package Options Include Plastic Small-Outline (SOIC) and Shrink Small-Outline (SSOP) Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs

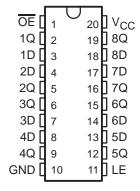
#### description

These 8-bit latches feature 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. They are particularly suitable for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

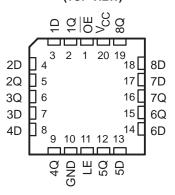
The eight latches of the 'F373 are transparent D-type latches. While the latch-enable (LE) input is high, the Q outputs will follow the data (D) inputs. When the latch enable is taken low, the Q outputs are latched at the logic levels set up at the D inputs.

A buffered output-enable  $(\overline{OE})$  input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

SN54F373 . . . J PACKAGE SN74F373 . . . DB, DW, OR N PACKAGE (TOP VIEW)



SN54F373 . . . FK PACKAGE (TOP VIEW)



The output-enable  $(\overline{OE})$  input does not affect the internal operations of the latches. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The SN74F373 is available in Tl's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54F373 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74F373 is characterized for operation from  $0^{\circ}$ C to  $70^{\circ}$ C.

# FUNCTION TABLE (each latch)

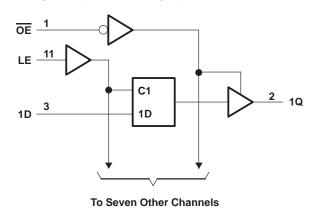
- 4							
		INPUTS	OUTPUT				
	OE	LE	D	Q			
	L	Н	Н	Н			
	L	Н	L	L			
	L	L	Χ	Q <sub>0</sub>			
	Н	Χ	Χ	Z			



### logic symbol†

#### OE ΕN 11 LE C1 3 2 1D 1D 1Q 5 4 2D 2Q 7 6 3D **3Q** 8 9 4D **4Q** 13 12 5D 5Q 14 15 6D 6Q 17 16 7D **7Q** 18 19 8D 8Q

### logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V <sub>CC</sub>	
Input voltage range, V <sub>I</sub> (see Note 1)	1.2 V to 7 V
Input current range	30 mA to 5 mA
Voltage range applied to any output in the disabled or power-off state	
Voltage range applied to any output in the high state	$-0.5 \text{ V to V}_{CC}$
Current into any output in the low state: SN54F373	40 mÅ
SN74F373	48 mA
Operating free-air temperature range: SN54F373	–55°C to 125°C
SN74F373	0°C to 70°C
Storage temperature range	65°C to 150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

#### recommended operating conditions

		SN54F373			S	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
lik	Input clamp current			-18			-18	mA
loh	High-level output current			-3			-3	mA
loL	Low-level output current			20			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C



<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TES	T CONDITIONS	s	SN54F373		SN74F373			UNIT	
PARAMETER	IES	I CONDITIONS	MIN	MIN TYP <sup>†</sup> MAX			TYP <sup>†</sup>	MAX	ONIT	
VIK	$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V	
	$V_{CC} = 4.5 \text{ V}$ $I_{OH} = -1 \text{ mA}$ 2.5	3.4		2.5	3.4					
VOH	vCC = 4.3 v	$I_{OH} = -3 \text{ mA}$	2.4	3.3		2.4	3.3		_ v	
	V <sub>CC</sub> = 4.75 V,	$I_{OH} = -1 \text{ mA to } -3 \text{ mA}$				2.7				
V <sub>OL</sub>	V <sub>CC</sub> = 4.5 V	$I_{OL} = 20 \text{ mA}$		0.3	0.5				V	
VOL	VCC = 4.3 V	$I_{OL} = 24 \text{ mA}$					0.35	0.5	v	
lozh	$V_{CC} = 5.5 \text{ V},$	$V_0 = 2.7 \text{ V}$			50			50	μΑ	
lozL	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 0.5 V			-50			-50	μΑ	
lį	V <sub>CC</sub> = 5.5 V,	V <sub>I</sub> = 7 V			0.1			0.1	mA	
lіН	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 2.7 V			20			20	μΑ	
Ι <sub>Ι</sub> L	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0.5 V			- 0.6			- 0.6	mA	
los <sup>‡</sup>	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 0	-60		-150	-60		-150	mA	
lccz	$V_{CC} = 5.5 \text{ V},$	See Note 2		38	55		38	55	mA	

<sup>&</sup>lt;sup>†</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

NOTE 2: I<sub>CCZ</sub> is measured with OE at 4.5 V and all other inputs grounded.

# timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

			V <sub>CC</sub> = 5 V, T <sub>A</sub> = 25°C		SN54F373		SN74F373	
			MAX	MIN	MAX	MIN	MAX	
t <sub>W</sub>	Pulse duration, LE high	6		6		6		ns
t <sub>su</sub>	Setup time, data before LE↓	2		2		2		ns
th	Hold time, data after LE↓	3		3		3		ns

### switching characteristics (see Note 3)

•	•	,									
PARAMETER	FROM (INPUT)	TO (OUTPUT)	C <sub>I</sub> R <sub>I</sub>	CC = 5 V = 50 pl = 500 9 = 25°C	F, Ω,	C <sub>L</sub> R <sub>L</sub>	= 50 pF = 500 Ω		V,	UNIT	
	, ,	, ,		′F373		SN54	F373	SN74	F373		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX		
<sup>t</sup> PLH	D	5	_	2.2	4.9	7	2.2	8.5	2.2	8	ns
t <sub>PHL</sub>		Q	1.2	3.3	5	1.2	7	1.2	6	115	
<sup>t</sup> PLH	LE	_	4.2	8.6	11.5	4.2	15	4.2	13	ns	
t <sub>PHL</sub>	LE	Q	2.2	4.8	7	2.2	8.5	2.2	8	115	
<sup>t</sup> PZH	ŌĒ	_	1.2	4.6	11	1.2	13.5	1.2	12	ns	
t <sub>PZL</sub>	UE	Q	1.2	5.2	7.5	1.2	10	1.2	8.5	115	
<sup>t</sup> PHZ	ŌĒ	Q	1.2	4.1	6.5	1.2	10	1.2	7.5	ns	
t <sub>PLZ</sub>		~	1.2	3.4	6	1.2	7	1.2	6	115	

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 3: Load circuits and waveforms are shown in Section 1.



<sup>‡</sup> Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

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